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03-24-2005

RECOR

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To the Director of the U.S. Patents and Trademark Office: Please record the attached documents or the new address(es) below.

## 1. Name of conveying party(ies)/Execution Date(s):

LING CHEN February 22, 2002  
VINCENT KU February 21, 2002  
DIEN-YEH WU February 21, 2002  
HUA CHUNG February 25, 2002  
ALAN OUYE February 21, 2002  
NORMAN NAKASHIMA February 21, 2002

Execution Date(s) See Above

Additional name of conveying party(ies) attached? ☐ Yes ☒ No

## 2. Name and address of receiving party(ies)

Name: APPLIED MATERIALS, INC.Internal Address: Patent CounselStreet Address: P.O. Box 450-ACity: Santa ClaraState: CACountry: USA Zip: 95052Additional Name(s) & address(es) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License  
☐ Other \_\_\_\_\_

## 4. Application number(s) or patent number(s):

A. Patent Application No.(s)

☐ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

## 5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: Applied Materials, Inc.Internal Address: Patent CounselStreet Address: P.O. Box 450-ACity: Santa ClaraState: CA Zip: 95052Phone Number : 713-623-4844Fax Number: 713-623-4846Email Address: tpatterson@mpsllp.com6. Total number of applications and patents involved: 17. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card  
☒ Authorized to be charged to deposit account  
☐ Enclosed  
☐ None required (government interest not affecting title)

## 8. Payment Information

a. Credit Card Last 4 Numbers \_\_\_\_\_

Expiration Date \_\_\_\_\_

b. Deposit Account Number 50-1074/5192.C1/CP/COPPER/PJS

Authorized User Name \_\_\_\_\_

## 9. Signature :

Robert W. Mulcahy  
SignatureMarch 11, 2005

Date

03/23/2005 DEVRNE 00000056 501074 11077753

01 FC:8021

(40.00 DA)

Robert W. Mulcahy; Reg No. 25,436

Name of Person Signing

Total number of pages, sheet, attachments,  
and documents including cover

13

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses  
of Inventors:

1)	Ling Chen 784 Dartshire Way Sunnyvale, CA 94087	2)	Vincent Ku 1830 Daltrey Way San Jose, CA 95132
3)	Dien-Yeh Wu 3625 Rowley Drive San Jose, CA 95132	4)	Hua Chung 4645 Piper Drive San Jose, CA 95129
5)	Alan Ouye 716 North Idaho Street San Mateo, CA 94401	6)	Norman Nakashima 841 Lincoln Avenue Sunnyvale, CA 94086

(hereinafter referred to as Assignors), have invented a certain invention entitled:

**GAS DELIVERY APPARATUS AND METHOD FOR ATOMIC LAYER DEPOSITION**for which application for Letters Patent in the United States was filed on 12/21/2001,  
under Serial No. 10/032,284; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.


2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths,

specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	<u>2-22-02</u>	 _____ Ling Chen
2)	_____	_____ Vincent Ku
3)	_____	_____ Dien-Yeh Wu
4)	_____	_____ Hua Chung
5)	_____	_____ Alan Ouye
6)	_____	_____ Norman Nakashima

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2)	<u>2-21-02</u>	<u><i>Vincent Ku</i></u>	Vincent Ku
3)	_____	_____	Dien-Yeh Wu
4)	_____	_____	Hua Chung
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3)	<u>2/21/2002</u>		Dien-Yeh Wu
4)	_____	_____	Hua Chung
5)	_____	_____	Alan Ouye
6)	_____	_____	Norman Nakashima

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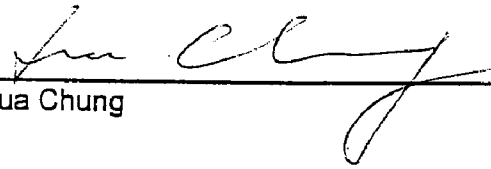


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Vincent Ku

3) \_\_\_\_\_  
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4) \_\_\_\_\_  
Hua Chung

5) 2/21/2002 \_\_\_\_\_  
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6) \_\_\_\_\_  
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A.N.

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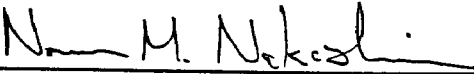
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